

Assembly Site Transfer of Select PBGA Products to ASE Kaohsiung (AEG)

BOM Change Summary

► ADSP-21060L, ADSP-21061L and ADSP-21160M

Assembly Site	ASE Chungli Taiwan – AET (From)	ASE Kaohsiung Taiwan – AEG (To)
Wire	Au / 1.2 mil	Au / 1.2 mil
Die Attach	AB-2100A Conductive	AB-2100AC Conductive
Mold Compound	Hitachi CEL-9750	Hitachi CEL-9750
Ball Size	0.75	0.75
Ball Composition	96.5Sn_3.0Ag_0.5Cu	96.5Sn_3.0Ag_0.5Cu

► ADSP-21160N

Assembly Site	ASE Chungli Taiwan – AET (From)	ASE Kaohsiung Taiwan – AEG (To)
Wire	Au / 1.0 mil	Au / 1.0 mil
Die Attach	AB-2100A Conductive	AB-2100A Conductive
Mold Compound	Hitachi CEL-9750	Hitachi CEL-9750
Ball Size	0.75	0.75
Ball Composition	96.5Sn_3.0Ag_0.5Cu	96.5Sn_3.0Ag_0.5Cu

► ADSP-BF561

Assembly Site	ASE Chungli Taiwan – AET (From)	ASE Kaohsiung Taiwan – AEG (To)
Wire	Au / 1.0 mil	Au / 1.0 mil
Die Attach	AB-2100A Conductive	AB-2100AC Conductive
Mold Compound	Hitachi CEL-9750	Hitachi CEL-9750
Ball Size	0.6	0.6
Ball Composition	96.5Sn_3.0Ag_0.5Cu	96.5Sn_3.0Ag_0.5Cu

► ADSP-TS101S

Assembly Site	ASE Chungli Taiwan – AET (From)	ASE Kaohsiung Taiwan – AEG (To)
Wire	Au / 1.2 mil	Au / 1.2 mil
Die Attach	AB-2100A Conductive	AB-2100AC Conductive
Mold Compound	Hitachi CEL-9750	Hitachi CEL-9750
Ball Size	0.6	0.6
Ball Composition	96.5Sn_3.0Ag_0.5Cu	96.5Sn_3.0Ag_0.5Cu